

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VCXH16646FT

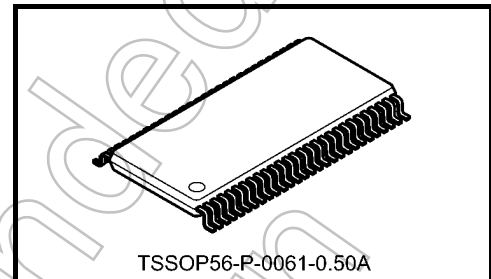
## Low-Voltage 16-Bit Bus Transceiver/Register with Bushold

The TC74VCXH16646FT is a high-performance CMOS 16-bit bus transceiver/register. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

This device is bus transceiver with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the internal registers.

The A, B data inputs include active bushold circuitry, eliminating the need for external pull-up resistors to hold unused or floating data inputs at a valid logic level.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.25 g (typ.)

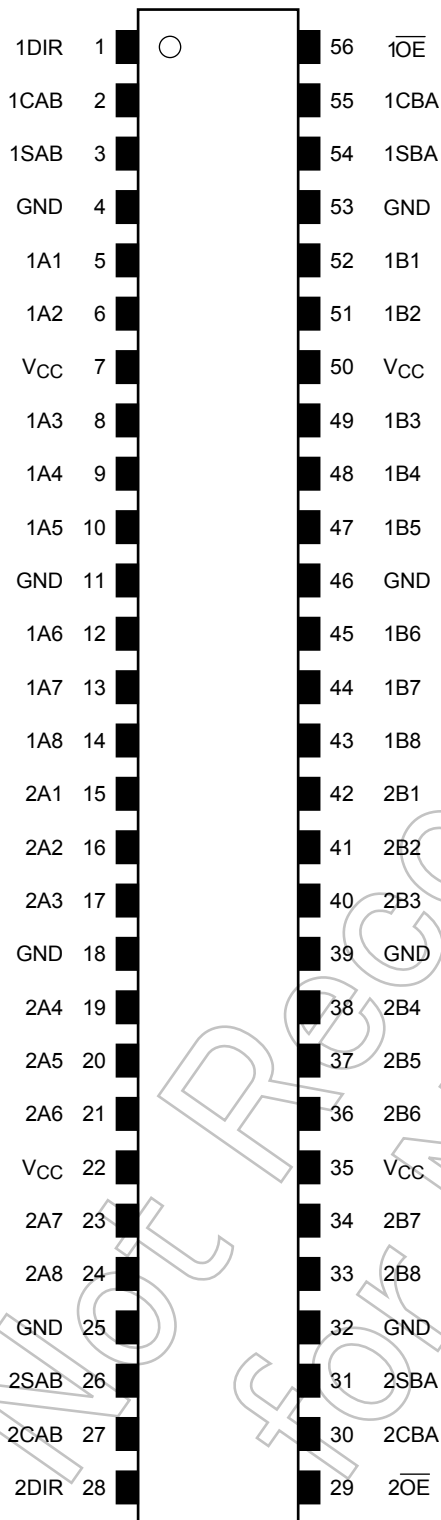
### Features (Note)

- Low-voltage operation:  $V_{CC} = 1.8$  to  $3.6$  V
- Bushold on data inputs eliminating the need for external pull-up/pull-down resistors
- High-speed operation :  $t_{pd} = 2.9$  ns (max) ( $V_{CC} = 3.0$  to  $3.6$  V)  
                                   :  $t_{pd} = 3.5$  ns (max) ( $V_{CC} = 2.3$  to  $2.7$  V)  
                                   :  $t_{pd} = 7.0$  ns (max) ( $V_{CC} = 1.8$  V)
- 3.6-V tolerant control inputs
- Output current:  $I_{OH}/I_{OL} = \pm 24$  mA (min) ( $V_{CC} = 3.0$  V)  
                                   :  $I_{OH}/I_{OL} = \pm 18$  mA (min) ( $V_{CC} = 2.3$  V)  
                                   :  $I_{OH}/I_{OL} = \pm 6$  mA (min) ( $V_{CC} = 1.8$  V)
- Latch-up performance:  $-300$  mA
- ESD performance: Machine model  $\geq \pm 200$  V  
                                   Human body model  $\geq \pm 2000$  V
- Package: TSSOP

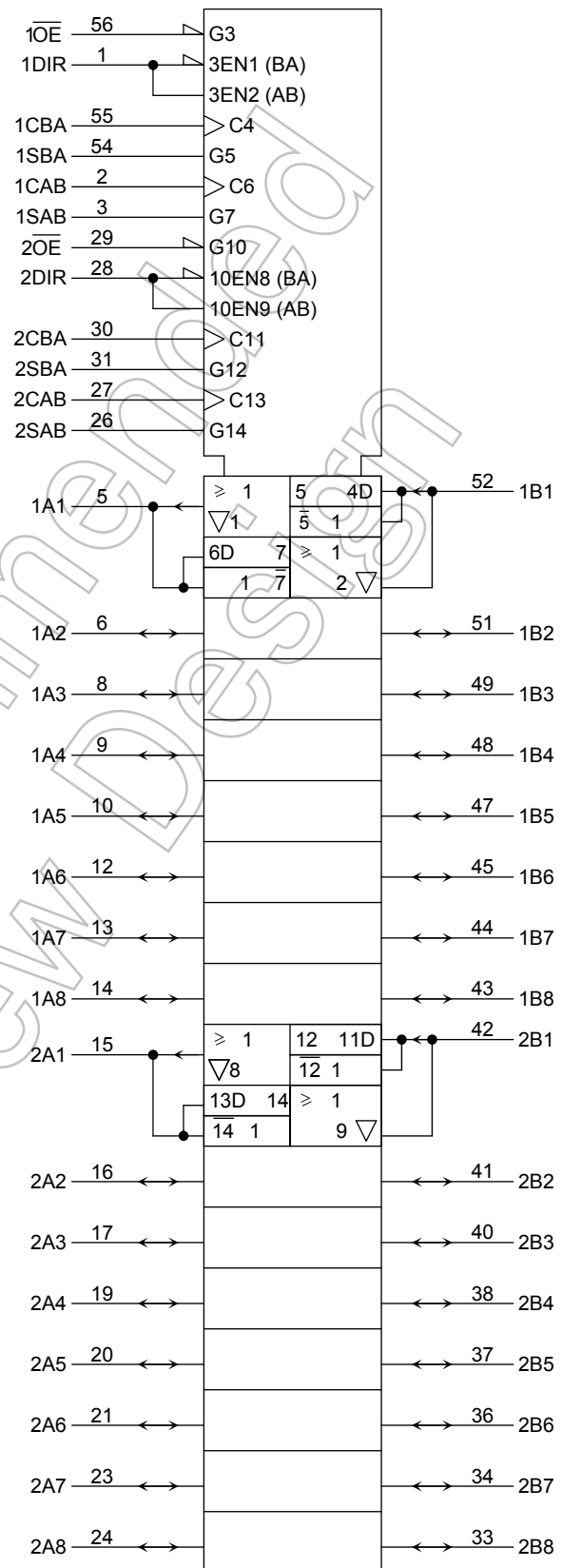
Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

Start of commercial production  
2001-03







## Pin Assignment (top view)



## IEC Logic Symbol



**Truth Table**

Control Inputs						Bus		Function
$\overline{OE}$	DIR	CAB	CBA	SAB	SBA	A	B	
H	X	X*	X*	X	X	Input	Input	The output functions of A and B Busses are disabled.
		Z	Z					
H	X			X	X	X	X	Both A and B Busses are used as inputs to the internal flip-flops. Data on the Bus will be stored on the rising edge of the Clock.
L	H	X*	X*	L	X	Input	Output	The data on the A bus are displayed on the B bus.
		L	L					
		H	H					
			X*	L	X	L	L	The data on the A bus are displayed on the B Bus, and are stored into the A storage flip-flops on the rising edge of CAB.
		H	H					
		X*	X*	H	X	X	Qn	The data in the A storage flop-flops are displayed on the B Bus.
L	L		X*	H	X	L	L	The data on the A Bus are stored into the A storage flip-flops on the rising edge of CAB, and the stored data propagate directly onto the B Bus.
		H	H					
		X*	X*	X	L	Output	Input	The data on the B Bus are displayed on the A bus.
		L	L					
X*		X	L	L	L	The data on the B Bus are displayed on the A Bus, and are stored into the B storage flip-flops on the rising edge of CBA.		
H	H							
X*	X*	X	H	Qn	X	The data in the B storage flip-flops are displayed on the A Bus.		
L	L	X*		X	H	L	L	The data on the B Bus are stored into the B storage flip-flops on the rising edge of CBA, and the stored data propagate directly onto the A Bus.
		H	H					

X: Don't care

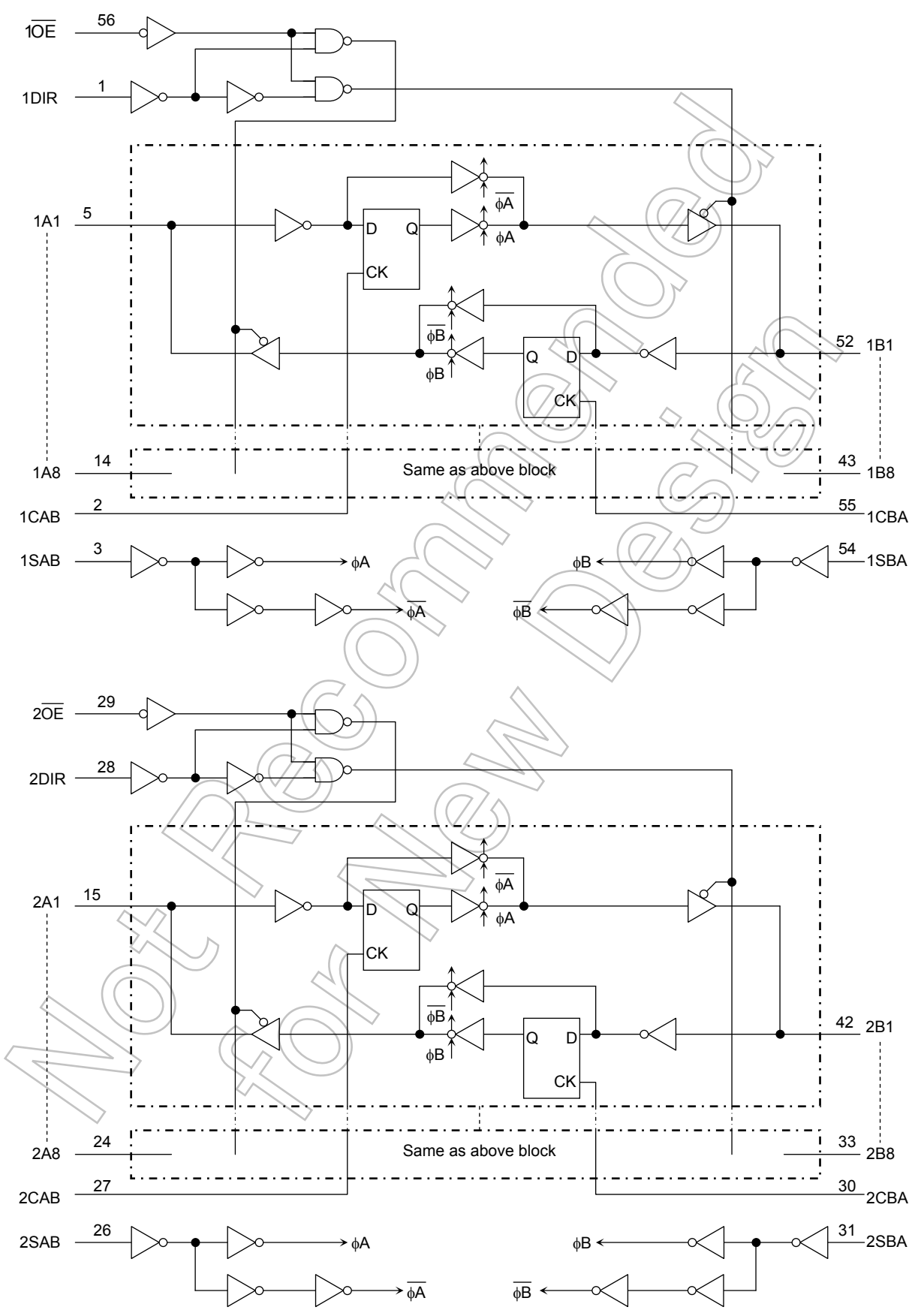
Z: High impedance

Qn: The data stored into the internal flip-flops by most recent low to high transition of the clock inputs.

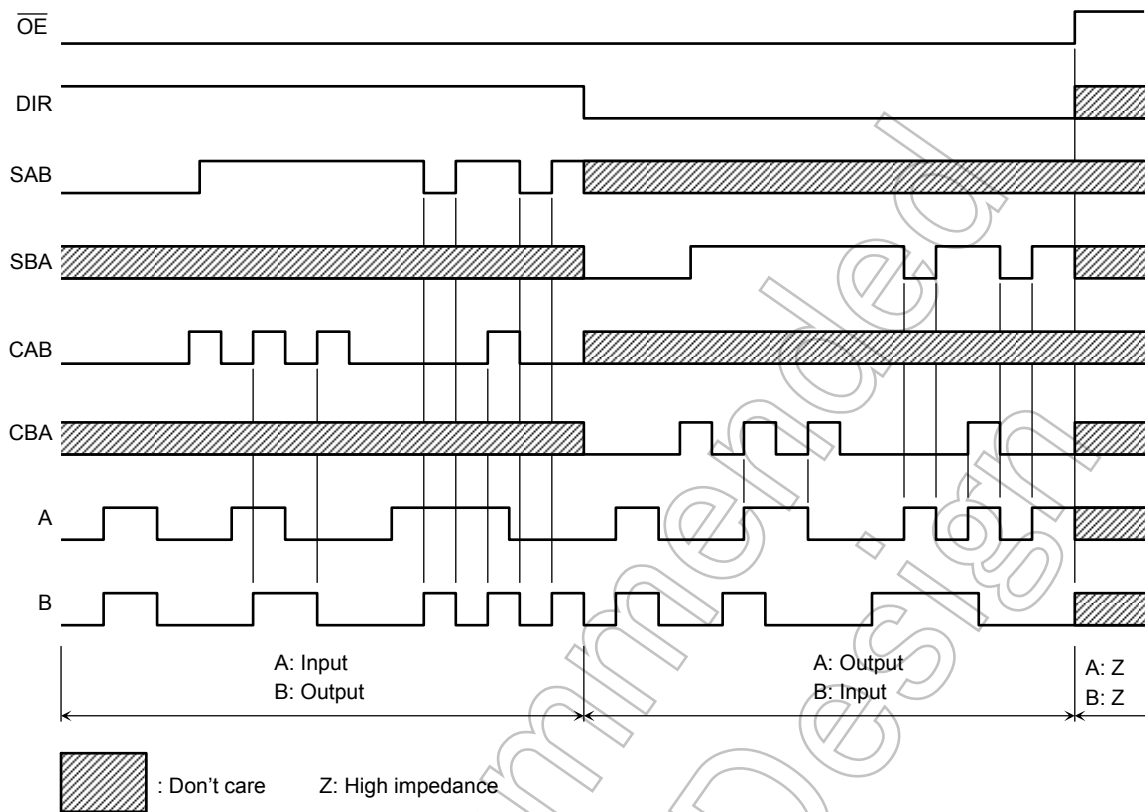
\*: The clocks are not internally with either  $\overline{OE}$  or DIR.

Therefore, data on the A and/or B busses may be clocked into the storage flip-flops at any time.

**System Diagram**



**Timing Chart**



**Absolute Maximum Ratings (Note 1)**

Characteristics		Symbol	Rating	Unit
Power supply voltage		$V_{CC}$	-0.5 to 4.6	V
DC input voltage	(DIR, $\overline{OE}$ , CAB, CBA, SAB, SBA)	$V_{IN}$	-0.5 to 4.6	V
	(An, Bn)		-0.5 to $V_{CC} + 0.5$ (Note 2)	
DC output voltage	(An, Bn)	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$ (Note 3)	V
Input diode current		$I_{IK}$	-50	mA
Output diode current		$I_{OK}$	$\pm 50$ (Note 4)	mA
Output current		$I_{OUT}$	$\pm 50$	mA
Power dissipation		$P_D$	400	mW
DC $V_{CC}$ /ground current per supply pin		$I_{CC}/I_{GND}$	$\pm 100$	mA
Storage temperature		$T_{stg}$	-65 to 150	$^{\circ}C$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: OFF state

Note 3: High or low state.  $I_{OUT}$  absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND$ ,  $V_{OUT} > V_{CC}$

**Operating Ranges (Note 1) (Note 2)**

Characteristics		Symbol	Rating	Unit
Power supply voltage		V <sub>CC</sub>	1.8 to 3.6	V
			1.2 to 3.6 (Note 3)	
Input voltage	(DIR, $\overline{OE}$ , CAB, CBA, SAB, SBA)	V <sub>IN</sub>	-0.3 to 3.6	V
	(An, Bn)		0 to V <sub>CC</sub> (Note 4)	
Output voltage	(An, Bn)	V <sub>OUT</sub>	0 to V <sub>CC</sub> (Note 5)	V
Output current		I <sub>OH</sub> /I <sub>OL</sub>	±24 (Note 6)	mA
			±18 (Note 7)	
			±6 (Note 8)	
Operating temperature		T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time		dt/dv	0 to 10 (Note 9)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 2: Floating or unused control inputs must be held high or low.

Note 3: Data retention only

Note 4: OFF state

Note 5: High or low state

Note 6: V<sub>CC</sub> = 3.0 to 3.6 V

Note 7: V<sub>CC</sub> = 2.3 to 2.7 V

Note 8: V<sub>CC</sub> = 1.8 V

Note 9: V<sub>IN</sub> = 0.8 to 2.0 V, V<sub>CC</sub> = 3.0 V

Not Recommended for New Design

## Electrical Characteristics

### DC Characteristics (Ta = -40 to 85°C, 2.7 V < VCC ≤ 3.6 V)

Characteristics		Symbol	Test Condition		VCC (V)	Min	Max	Unit
Input voltage	H-level	V <sub>IH</sub>	—		2.7 to 3.6	2.0	—	V
	L-level	V <sub>IL</sub>	—		2.7 to 3.6	—	0.8	
Output voltage	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	—	V
				I <sub>OH</sub> = -12 mA	2.7	2.2	—	
				I <sub>OH</sub> = -18 mA	3.0	2.4	—	
				I <sub>OH</sub> = -24 mA	3.0	2.2	—	
	L-level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.7 to 3.6	—	0.2	
				I <sub>OL</sub> = 12 mA	2.7	—	0.4	
				I <sub>OL</sub> = 18 mA	3.0	—	0.4	
				I <sub>OL</sub> = 24 mA	3.0	—	0.55	
Input leakage current (DIR, OE, CAB, CBA, SAB, SBA)		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		2.7 to 3.6	—	±5.0	μA
Bushold input minimum drive hold current		I <sub>I (HOLD)</sub>	V <sub>IN</sub> = 0.8 V		3.0	75	—	μA
			V <sub>IN</sub> = 2.0 V		3.0	-75	—	
Bushold input over-drive current to change state		I <sub>I (OD)</sub>	(Note 1)		3.6	—	450	μA
			(Note 2)		3.6	—	-450	
3-state output OFF state current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	—	±10.0	μA
Quiescent supply current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	—	20.0	μA
Increase in I <sub>CC</sub> per input		ΔI <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		2.7 to 3.6	—	750	μA

Note 1: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 2: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

**DC Characteristics (Ta = -40 to 85°C, 2.3 V ≤ VCC ≤ 2.7 V)**

Characteristics		Symbol	Test Condition		VCC (V)	Min	Max	Unit
Input voltage	H-level	V <sub>IH</sub>	—		2.3 to 2.7	1.6	—	V
	L-level	V <sub>IL</sub>	—		2.3 to 2.7	—	0.7	
Output voltage	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.3 to 2.7	V <sub>CC</sub> - 0.2	—	V
				I <sub>OH</sub> = -6 mA	2.3	2.0	—	
				I <sub>OH</sub> = -12 mA	2.3	1.8	—	
				I <sub>OH</sub> = -18 mA	2.3	1.7	—	
	L-level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.3 to 2.7	—	0.2	
				I <sub>OL</sub> = 12 mA	2.3	—	0.4	
I <sub>OL</sub> = 18 mA				2.3	—	0.6		
Input leakage current (DIR, $\overline{OE}$ , CAB, CBA, SAB, SBA)		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		2.3 to 2.7	—	±5.0	μA
Bushold input minimum drive hold current		I <sub>I</sub> (HOLD)	V <sub>IN</sub> = 0.7 V		2.3	45	—	μA
			V <sub>IN</sub> = 1.6 V		2.3	-45	—	
Bushold input over-drive current to change state		I <sub>I</sub> (OD)	(Note 1)		2.7	—	300	μA
			(Note 2)		2.7	—	-300	
3-state output OFF state current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		2.3 to 2.7	—	±10.0	μA
Quiescent supply current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3 to 2.7	—	20.0	μA

Note 1: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 2: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Not Recommended for New Design



**DC Characteristics (Ta = -40 to 85°C, 1.8 V ≤ VCC < 2.3 V)**

Characteristics		Symbol	Test Condition		VCC (V)	Min	Max	Unit
Input voltage	H-level	V <sub>IH</sub>	—		1.8 to 2.3	0.7 × V <sub>CC</sub>	—	V
	L-level	V <sub>IL</sub>	—		1.8 to 2.3	—	0.2 × V <sub>CC</sub>	
Output voltage	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	1.8	V <sub>CC</sub> - 0.2	—	V
				I <sub>OH</sub> = -6 mA	1.8	1.4	—	
	L-level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	1.8	—	0.2	
				I <sub>OL</sub> = 6 mA	1.8	—	0.3	
Input leakage current (DIR, $\overline{OE}$ , CAB, CBA, SAB, SBA)		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		1.8	—	±5.0	μA
Bushold input minimum drive hold current		I <sub>I</sub> (HOLD)	V <sub>IN</sub> = 0.36 V		1.8	25	—	μA
			V <sub>IN</sub> = 1.26 V		1.8	-25	—	
Bushold input over-drive current to change state		I <sub>I</sub> (OD)	(Note 1)		1.8	—	200	μA
			(Note 2)		1.8	—	-200	
3-state output OFF state current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		1.8	—	±10.0	μA
Quiescent supply current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		1.8	—	20.0	μA

Note 1: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 2: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Not Recommended for New Design

## AC Characteristics (Ta = -40 to 85°C, input: tr = tf = 2.0 ns, CL = 30 pF, RL = 500 Ω) (Note 1)

Characteristics	Symbol	Test Condition	VCC (V)	Min	Max	Unit
Maximum clock frequency	f <sub>max</sub>	Figure 1, Figure 3	1.8	100	—	MHz
			2.5 ± 0.2	200	—	
			3.3 ± 0.3	250	—	
Propagation delay time (An, Bn-Bn, An)	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	1.8	1.5	7.0	ns
			2.5 ± 0.2	0.8	3.5	
			3.3 ± 0.3	0.6	2.9	
Propagation delay time (CAB, CBA-Bn, An)	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 3	1.8	1.5	8.8	ns
			2.5 ± 0.2	0.8	4.4	
			3.3 ± 0.3	0.6	3.2	
Propagation delay time (SAB, SBA-Bn, An)	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	1.8	1.5	8.8	ns
			2.5 ± 0.2	0.8	4.4	
			3.3 ± 0.3	0.6	3.5	
Output enable time ( $\overline{OE}$ , DIR-An, Bn)	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 4, Figure 5	1.8	1.5	9.8	ns
			2.5 ± 0.2	0.8	4.9	
			3.3 ± 0.3	0.6	3.8	
Output disable time ( $\overline{OE}$ , DIR-An, Bn)	t <sub>pLZ</sub> t <sub>pHZ</sub>	Figure 1, Figure 4, Figure 5	1.8	1.5	7.6	ns
			2.5 ± 0.2	0.8	4.2	
			3.3 ± 0.3	0.6	3.7	
Minimum pulse width	t <sub>w</sub> (H) t <sub>w</sub> (L)	Figure 1, Figure 3	1.8	4.0	—	ns
			2.5 ± 0.2	1.5	—	
			3.3 ± 0.3	1.5	—	
Minimum setup time	t <sub>s</sub>	Figure 1, Figure 3	1.8	2.5	—	ns
			2.5 ± 0.2	1.5	—	
			3.3 ± 0.3	1.5	—	
Minimum hold time	t <sub>h</sub>	Figure 1, Figure 3	1.8	1.0	—	ns
			2.5 ± 0.2	1.0	—	
			3.3 ± 0.3	1.0	—	
Output to output skew	t <sub>osLH</sub> t <sub>osHL</sub>	(Note 2)	1.8	—	0.5	ns
			2.5 ± 0.2	—	0.5	
			3.3 ± 0.3	—	0.5	

Note 1: For C<sub>L</sub> = 50 pF, add approximately 300 ps to the AC maximum specification.

Note 2: Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

**Dynamic Switching Characteristics**

(Ta = 25°C, input: tr = tf = 2.0 ns, CL = 30 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition		Typ.	Unit	
			VCC (V)			
Quiet output maximum dynamic VOL	VOLP	VIH = 1.8 V, VIL = 0 V	(Note)	1.8	0.25	V
		VIH = 2.5 V, VIL = 0 V	(Note)	2.5	0.6	
		VIH = 3.3 V, VIL = 0 V	(Note)	3.3	0.8	
Quiet output minimum dynamic VOL	VOLV	VIH = 1.8 V, VIL = 0 V	(Note)	1.8	-0.25	V
		VIH = 2.5 V, VIL = 0 V	(Note)	2.5	-0.6	
		VIH = 3.3 V, VIL = 0 V	(Note)	3.3	-0.8	
Quiet output minimum dynamic VOH	VOHV	VIH = 1.8 V, VIL = 0 V	(Note)	1.8	1.5	V
		VIH = 2.5 V, VIL = 0 V	(Note)	2.5	1.9	
		VIH = 3.3 V, VIL = 0 V	(Note)	3.3	2.2	

Note: Parameter guaranteed by design.

**Capacitive Characteristics (Ta = 25°C)**

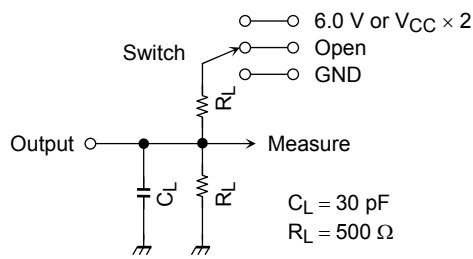
Characteristics	Symbol	Test Condition		Typ.	Unit	
			VCC (V)			
Input capacitance	CIN	(DIR, OE, CAB, CBA, SAB, SBA)		1.8, 2.5, 3.3	6	pF
Bus I/O capacitance	CIO	—		1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	CPD	fIN = 10 MHz	(Note)	1.8, 2.5, 3.3	20	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$$

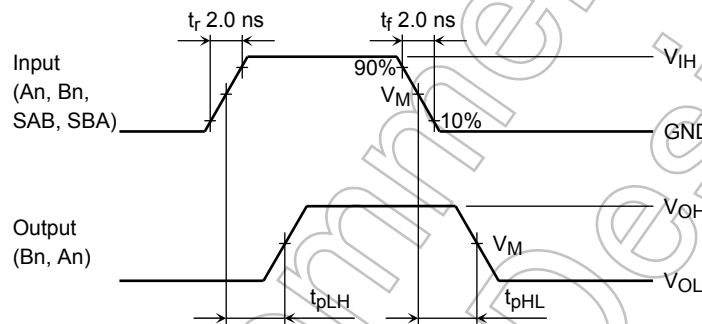
**AC Test Circuit**



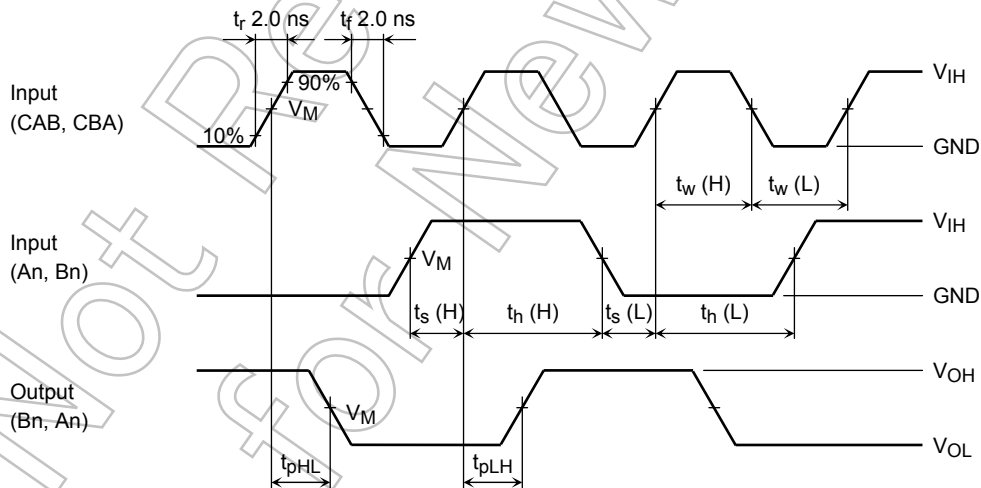
Parameter	Switch
$t_{pLH}$ , $t_{pHL}$	Open
$t_{pLZ}$ , $t_{pZL}$	6.0 V $V_{CC} \times 2$ @ $V_{CC} = 3.3 \pm 0.3 \text{ V}$ @ $V_{CC} = 2.5 \pm 0.2 \text{ V}$ @ $V_{CC} = 1.8 \text{ V}$
$t_{pHZ}$ , $t_{pZH}$	GND

**Figure 1**

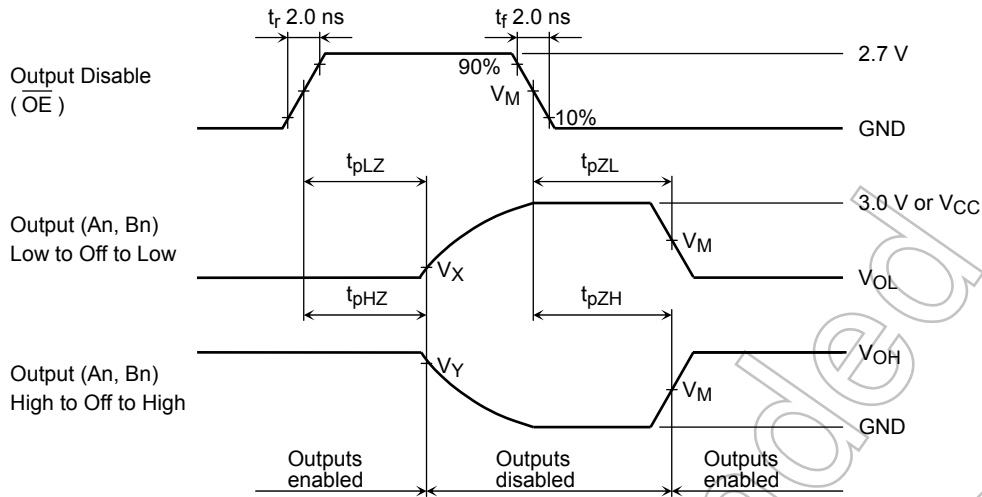
**AC Waveform**



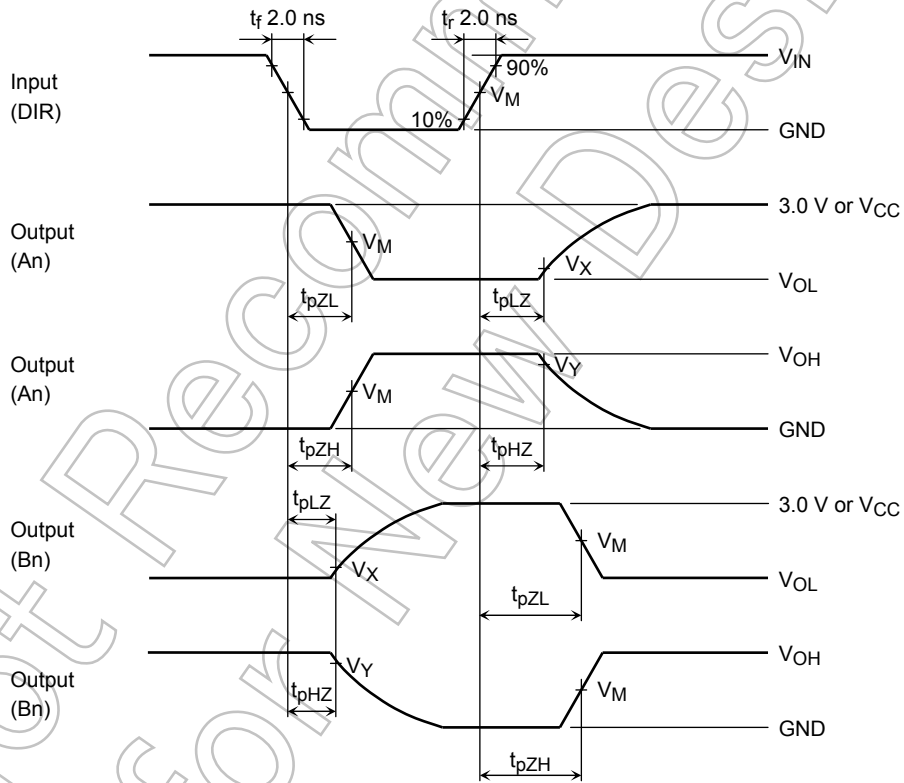
**Figure 2  $t_{pLH}$ ,  $t_{pHL}$**



**Figure 3  $t_{pLH}$ ,  $t_{pHL}$ ,  $t_w$ ,  $t_s$ ,  $t_h$**



**Figure 4**  $t_{pLZ}$ ,  $t_{pH}$ ,  $t_{pZ}$ ,  $t_{pZH}$



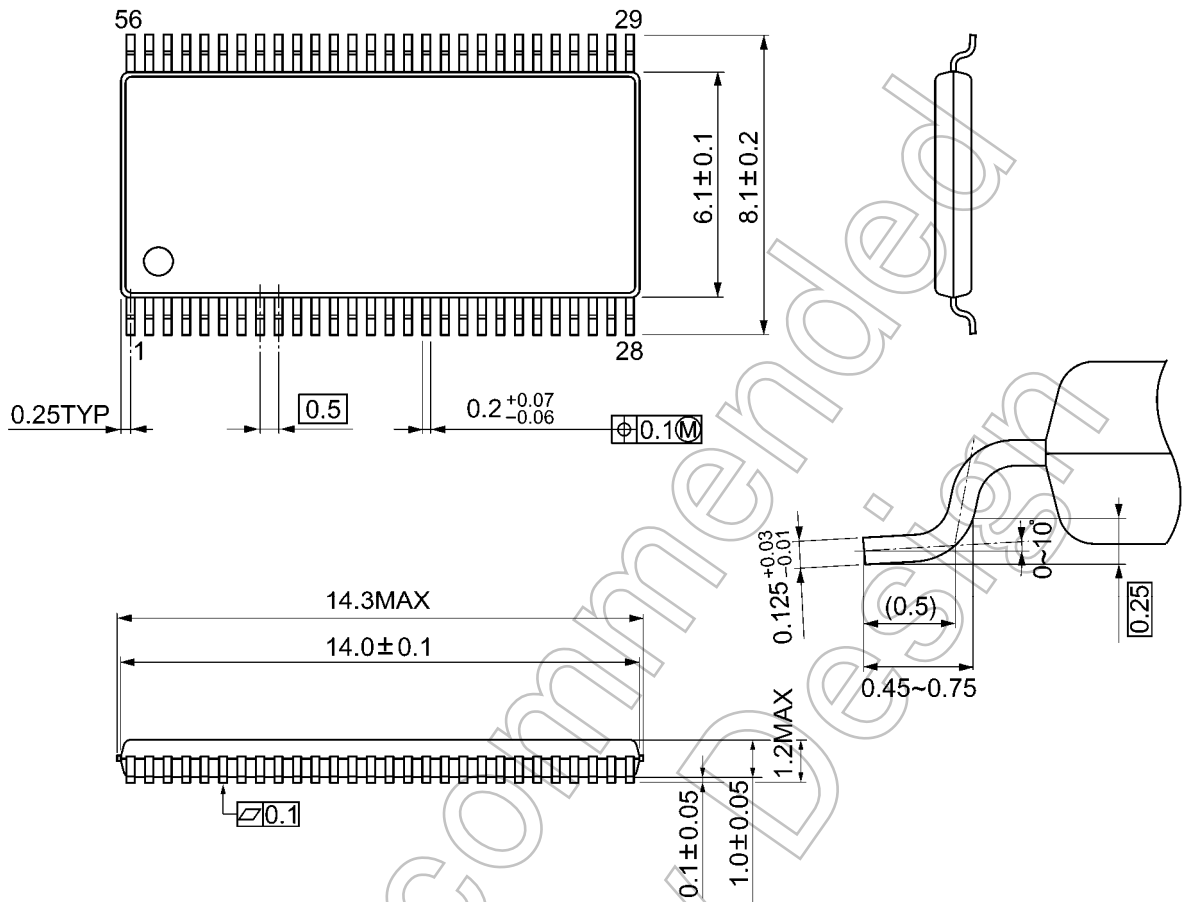
**Figure 5**  $t_{pLZ}$ ,  $t_{pH}$ ,  $t_{pZ}$ ,  $t_{pZH}$

Symbol	$V_{CC}$		
	$3.3 \pm 0.3 \text{ V}$	$2.5 \pm 0.2 \text{ V}$	$1.8 \text{ V}$
$V_{IH}$	$2.7 \text{ V}$	$V_{CC}$	$V_{CC}$
$V_M$	$1.5 \text{ V}$	$V_{CC}/2$	$V_{CC}/2$
$V_X$	$V_{OL} + 0.3 \text{ V}$	$V_{OL} + 0.15 \text{ V}$	$V_{OL} + 0.15 \text{ V}$
$V_Y$	$V_{OH} - 0.3 \text{ V}$	$V_{OH} - 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$

**Package Dimensions**

TSSOP56-P-0061-0.50A

Unit: mm



Weight: 0.25 g (typ.)

Not Recommended for New Design

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